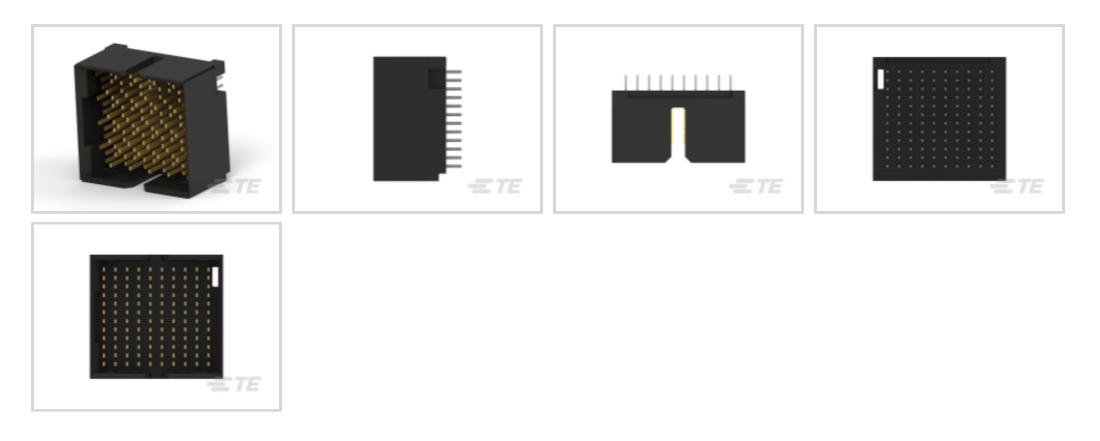


Z-PACK | Z-PACK TinMan

TE Internal #: 1934312-1 120 Position High Speed Backplane Connector, 12 Row, 10 Column, PCB Mount Header, Vertical, Fully Shrouded, 1.9 mm [.075 in] Centerline, Z-PACK TinMan

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Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Number of Positions: 120 Row-to-Row Spacing: 1.4 mm [.055 in] Mating Alignment: With Mating Alignment Type: Guide Slot

Number of Rows: 12

Features



Product Type Features

Signal Arrangement	Differential
Connector & Contact Terminates To	Printed Circuit Board
Connector System	Board-to-Board
PCB Connector Type	PCB Mount Header
Shroud Style	Fully Shrouded
Configuration Features	
Number of Pairs	40
Number of Signal Positions	80
Backplane Architecture	Traditional Backplane
Stackable	No
Pairs per Column	4
Number of Positions	120
Number of Rows	12
Number of Columns	10

120 Position High Speed Backplane Connector, 12 Row, 10 Column, PCB Mount Header, Vertical, Fully Shrouded, 1.9 mm [.075 in] Centerline, Z-PACK TinMan



PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	250 VAC
Impedance	100 Ω
Signal Characteristics	
Data Rate	10 Gb/s
Differential Impedance	100 Ω
Number of Differential Pairs per Column	4
Body Features	
Primary Product Color	Black
Contact Features	
PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]
PCB Contact Termination Area Plating Material Thickness	.5 μm[20 μin]
Contact Shape & Form	Rectangular
Contact Mating Area Plating Material	Gold (Au)
Contact Mating Area Length	6 mm[.236 in]
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	.5 A
Termination Features	
Termination Method to PCB	Through Hole - Press-Fit
Termination Post & Tail Length	2.5 mm[.098 in]
Mechanical Attachment	
Guide Hardware	Without
PCB Mount Retention	With
Mating Retention	Without
PCB Mount Retention Type	Action/Compliant Tail
PCB Mount Alignment	Without
Mating Alignment	With
Mating Alignment Type	Guide Slot

120 Position High Speed Backplane Connector, 12 Row, 10 Column, PCB Mount Header, Vertical, Fully Shrouded, 1.9 mm [.075 in] Centerline, Z-PACK TinMan



Connector Mounting Type	Board Mount
Housing Features	
Number of Shrouded Sides	4
End Wall Location	Dual
Housing Material	LCP
Centerline (Pitch)	1.9 mm[.075 in]
Dimensions	
Connector Width	20.2 mm
Connector Height	11.8 mm
PCB Hole Diameter	.47 mm
Connector Length	11.8 mm
Row-to-Row Spacing	1.4 mm[.055 in]
Usage Conditions	
Operating Temperature Range	-65 – 90 °C[-85 – 194 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	

UL
UL 94V-0
UL E28476
Box & Tube, Tube
Compliant
Compliant
No Restricted Materials Above Threshold
Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247)

120 Position High Speed Backplane Connector, 12 Row, 10 Column, PCB Mount Header, Vertical, Fully Shrouded, 1.9 mm [.075 in] Centerline, Z-PACK TinMan



Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

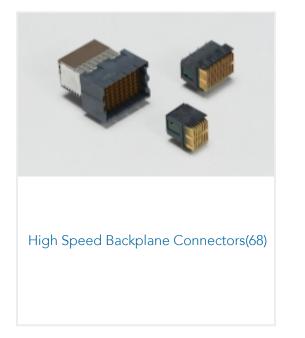
Compatible Parts







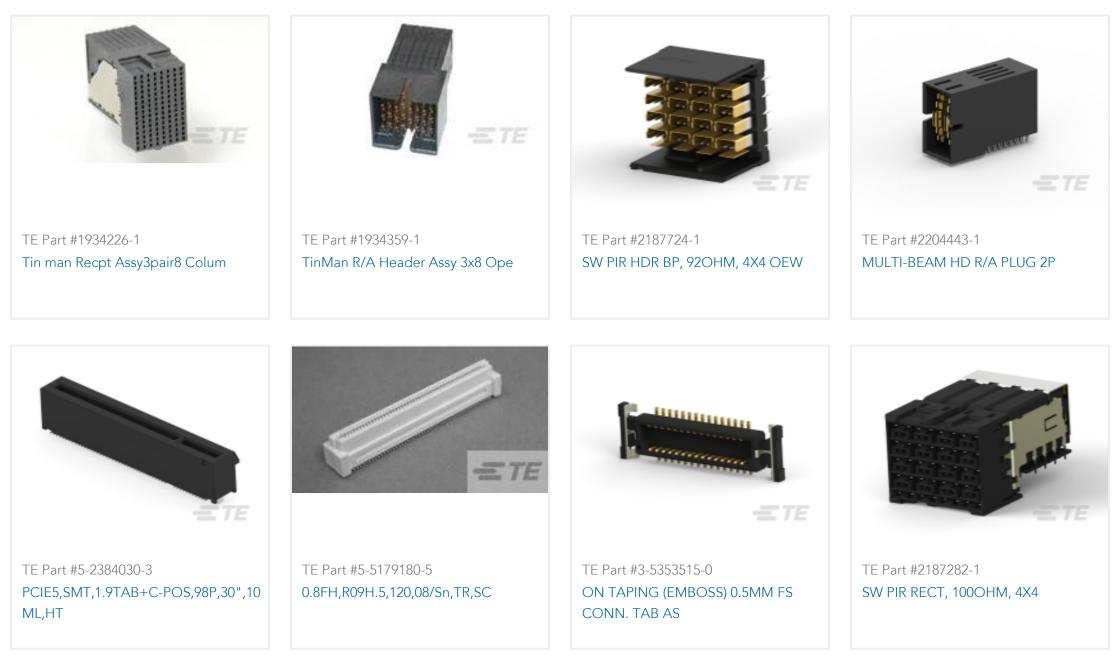
Also in the Series Z-PACK TinMan



Customers Also Bought

120 Position High Speed Backplane Connector, 12 Row, 10 Column, PCB Mount Header, Vertical, Fully Shrouded, 1.9 mm [.075 in] Centerline, Z-PACK TinMan







Documents

Product Drawings TinMan Header Assy 4x10Double

English

CAD Files

Customer View Model ENG_CVM_CVM_1934312-1_A.2d_dxf.zip

English

3D PDF

3D

Customer View Model ENG_CVM_CVM_1934312-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1934312-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

C For support call+1 800 522 6752

120 Position High Speed Backplane Connector, 12 Row, 10 Column, PCB Mount Header, Vertical, Fully Shrouded, 1.9 mm [.075 in] Centerline, Z-PACK TinMan



High Speed Backplane Connectors catalog - Z-PACK TinMan High Speed, High Density Backplane Connector

English

Stacking Connectors Quick Reference Guide (English)

English

Product Specifications Application Specification

English